



GAP PAD TGP 5000

Known as GAP PAD 5000 S35
October 2018

PRODUCT DESCRIPTION

High thermal conductivity plus “S-Class” softness and conformability.

Technology	Silicone
Appearance	Light green
Reinforcement Carrier	Fibreglass
Thickness	0.508 to 3.175mm , ASTM D374
Inherent Surface Tack	2 (1 sided)
Application	Thermal management, TIM (Thermal Interface Material)
Operating Temperature Range	-60 to 200°C

FEATURES AND BENEFITS

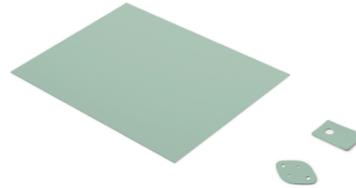
- High Thermal Conductivity: 5.0 W/m-K
- Highly conformable, “S-Class” softness
- Natural inherent tack reduces interfacial thermal resistance
- Conforms to demanding contours and maintains structural integrity with little or no stress applied to fragile component leads
- Fibreglass reinforced for puncture, shear and tear resistance
- Excellent thermal performance at low pressures

GAP PAD TGP 5000 is a fibreglass-reinforced filler and polymer featuring a high thermal conductivity. The material yields extremely soft characteristics while maintaining elasticity and conformability. The fibreglass reinforcement provides easy handling and converting, added electrical isolation and tear resistance. The inherent natural tack on both sides assists in application and allows the product to effectively fill air gaps, enhancing the overall thermal performance.

The top side has reduced tack for ease of handling. GAP PAD TGP 5000 is ideal for high-performance applications at low mounting pressures.

TYPICAL APPLICATIONS

- Voltage Regulator Modules (VRMs) and POLs
- CD/DVD ROM
- PC Board to chassis
- ASICs and DSPs
- Memory packages/modules
- Thermally-enhanced BGAs



TYPICAL PROPERTIES OF CURED MATERIAL

Young's modulus is calculated using 0.01 in/min, step rate of strain with a sample size 0.79 inch².

Physical Properties

Hardness, Shore 00	35
, Thirty second delay value	
, ASTM D2240, Bulk rubber	
Heat Capacity, ASTM E1269, J/g-K	1.0
Density, Bulk rubber, ASTM D792, g/cc	3.6
Flammability, UL 94	V-0
Young's Modulus, ASTM D575	kPa 310 (psi) (45)

Electrical Properties

Dielectric Breakdown Voltage, ASTM D149, VAC	>5,000
Dielectric Constant, ASTM D150, 1,000Hz	7.5
Volume Resistivity, ASTM D257, ohm-meter	1×10 ⁹

Thermal Properties

Thermal Conductivity, ASTM D5470, W/(m-K)	5.0
Thermal Impedance, 0.040 inch	
ASTM D5470, °C-in ² /W:	
10% Deflection	0.41
20% Deflection	0.34
30% Deflection	0.3

The recorded value includes interfacial thermal resistance. These values are provided for reference only. Actual application performance is directly related to the surface roughness, flatness and pressure applied.

GENERAL INFORMATION

For safe handling information on this product, consult the Safety Data Sheet, (SDS).

Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.



CONFIGURATIONS AVAILABLE

GAP PAD TGP 5000 is available in the following configurations:

Die-cut parts are available in any shape or size, separated or in sheet form

Natural tack both sides with fibreglass.

STORAGE

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Optimal Storage: 25°C (±3), 50% RH (±10) for a 12 months shelf life. Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

Disclaimer

Note:

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Reference 1

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Americas
+1.888.943.6535

Europe
+32.1457.5611

Asia
+86.21.3898.4800

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